| ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES® INTERNATION CONNECTING International and Pan-Ameri | nnockburn, Illinois. A | ll rights reserved u ntions. | nder both 1 | This docume level parts, t | ent is a declara he declaration | tion of the succession of the | ubstances s all lowe | within the manufacture revel materials for w | urer listed i which the r | tem. Note: if nanufacturer | the item is an as has engineering | ssembly with lower responsibility. | |
|---|--|------------------------------|-------------|-------------------------------|--|---|-------------------------|--|------------------------------|-------------------------------------|--------------------------------------|------------------------------------|--|
| | IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute | | | * | Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi | | | | rials and M | ials and Mfg Information | | | |
| Supplier Information | | | | | | | | | | | | | |
| Company name* Company unique ID | | | | Unique ID Authority | | | | | Response Date* | | | | |
| onsemi | emi | | | | 2025-06-05 | | | | | | | | |
| Contact Name | ntact Name Title - Contact | | |] | Phone - Contact* | | | | Email - | Email - Contact* | | | |
| Product-Env-Stewards Product Enviro Compliance | | | | | NA | | | | Produc | Product-Env-Stewards@onsemi.com | | | |
| thorized Representative* Title - Representative | | | | 1 | Phone - Representative* | | | | Email - | Email - Representative* | | | |
| Product-Env-Stewards Product Enviro Compliance | | | NA | | | P | | | Produc | Product-Env-Stewards@onsemi.com | | | |
| Requester Item Number M | Mfr Item Number Mfr Item Name | | | | Effective Da | e Version | I | Manufacturing Site | | Weight* | UOM | Unit Type | |
| С | CAT24C64BAC4CTR 64KB I2C SER EEP slave address compa CAT24C64C4CTR | | pare with | fferent | 2025-06-05 | | (| CNQ | | 0.3079 | mg | Each | |
| Manufacturing Proccess Information | | | | | | | | | | | | | |
| Terminal Plating / Grid Array Material | al Plating / Grid Array Material Terminal Base Alloy J-S | | | Rating | Peak Process Body Temperature Max Time at Peak | | | | k Tempera | Temperature Number of Reflow Cycles | | | |
| SnAgCu CU Alloy 1 | | 1 | | 260 | | С | 30 | secor | nds 3 | | | | |
| Comments | | | | | | | | | | | | | |
| evel 1 - maximum time at peak temperature du | ring soldering is 10-3 | 0 seconds | | | | | | | | | | | |
| for more information regarding material compo | osition please refer to | page 3 | | | | | | | | | | | |

| RoHS Material Composition Declaration | | | | Declaration Type * | Detailed | | | | | |
|---|--|-------------------------|---------------------------------|---|--|--|--|--|--|--|
| Directive 2015/863/EU amending RoHS Directive 2011/65/EU | RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP). | | | | | | | | | |
| Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member stuation. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, itsuppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms andConditions of Sale applicable to such part shall apply. | | | | | | | | | | |
| RoHS Declaration * 1 - Item(s) | does not contain RoHS restricted substa | ances per the definitio | on above | Supplier Acceptance | * Accepted | | | | | |
| Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions. | | | | | | | | | | |
| Exemption List Version | EL-2011/534/EU | | | | | | | | | |
| Declaration Signature | | | | | | | | | | |
| Instructions: Complete all of the required fin Requester) and click on Submit Form to have | elds on all pages of this form. Select the form returned to the Requester | he "Accepted" on th | e Supplier Acceptance drop-down | . This will display the signature area. Digital | lly sign the declaration (if required by the | | | | | |
| Supplier Digital Signature Ra | stislav Drska | Le | | | | | | | | |

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

| Substance Instructions: [A] select select a RoHS exemption, if applic sigma range of distribution unless | cable [E] enter the weigh | , Requester or Supplier) [B It of the substance or the Pl |] select the substa PM concentration | ance category (JIG or Requester) or [F] Optionally enter the positive (- | enter a value (Supplier). [C] selec -) and negative (-) tolerance in per | t the substance (JI cent (Note: percen | G) or enter the substa tt tolerance values are | nce and CAS (Other). [D] expected to cover a 3 |
|--|---------------------------|--|---|---|---|---|---|---|
| Homogeneous Material | Weight | Unit of Measure | Level | Substance | CAS | Exempt | Weight | Unit of Measure |
| Die | 0.2641 | mg | Supplier | Silicon (Si) | 7440-21-3 | | 0.2641 | mg |
| Protection coat | 0.0082 | mg | | Polyimide | proprietary data | | 0.0082 | mg |
| RDL | 0.0067 | mg | Supplier | Titanium (Ti) | 7440-32-6 | | 0.0001 | mg |
| | | | Supplier | Copper (Cu) | 7440-50-8 | | 0.0066 | mg |
| Solder Ball | 0.0222 | mg | Supplier | Silver (Ag) | 7440-22-4 | | 0.0006 | mg |
| | | | Supplier | Tin (Sn) | 7440-31-5 | | 0.0216 | mg |
| UBM Sputter | 0.0067 | mg | Supplier | Titanium (Ti) | 7440-32-6 | | 0 | mg |
| | | | Supplier | Copper (Cu) | 7440-50-8 | | 0.0067 | mg |